

Sure-form® One-Part Gap Filler

Product Code: 52153

TECHNICAL DATA SHEET



Product Description

AOS Sure-Form® Gap Filler 52153 is a dispensable, one-part, non-silicone gap filler. This dark gray product is very tacky, resists vibration and shock, will stay in place and not run, even under elevated use temperatures. This product is very viscous. The initial yield point is very high. The material will flow under higher shear and tends to increase in viscosity slightly over time. This solid is able to withstand temperatures in excess of 180 °C for short periods of time. 52153 was developed by AOS in response for a moderately priced product that adheres very well initially and stays put in place while still providing increased thermal transfer efficiency. The material appears compatible with most electronic materials. The material does not phase separate.

Product Features & Benefits

- AOS 52153 retains all the unique advantages of AOS Heat Sink Compound (Product Code: 52038) with the added benefit of high temperature use. The non-silicone, "no creep" feature extends OEM service life. It is compatible with most metal and plastic components. It has a five year minimum shelf life in its unopened container. Additional benefits include excellent thermal conductivity and thermal resistance over a wide operating temperature range.
- AOS 52153 is a much more cost effective gap filling solution compared to pre-formed gap pads. The product has considerably greater thermal conductivity than our standard non-silicone thermal grease, and can be modified by customer request.

Property	Value	Test Method
Specific Gravity, @ 25°C	2.7	ASTM D-70
Bleed, @ 200°C, 24 Hrs., %/Wt	0	FTM-321 MODIFIED
Evaporation, @ 200°C, 24 Hrs., %/Wt.	0	FTM-321 MODIFIED
Thermal Conductivity, @ 36°C	3.5	ASTM D-5470-06 @
W/m-K		(1, 2, 5, and 20 mils)
Anticipated Minimum Bond Line (mils)		
Based on filler Dimensions	3 mil	
Electrical Properties		
Dielectric Strength, 0.05" gap, V/mil	318	
Dielectric Strength after exposure to	212	ASTM D-149
85°C/85% R.H. for 48 hours		
Dielectric Constant, 25°C @ 1,000 Hz	5.0	ASTM D-150
Dissipation Factor, 25°C @ 1,000 Hz	0.0027	ASTM D-150
Volume Resistivity, ohm-cm	2.15×10^{15}	ASTM D-257
Operating Temperature Range	-40°C to 200°C	
Flow Rate grams/min (2 mm orifice @ 40	2-6	AOS METHOD # 2
Appearance	Gray Paste	

Typical Properties

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Please know that customers are responsible for testing AOS Thermal Compounds materials for their proposed use. Any information furnished by AOS Thermal Compounds and its agents is believed to be reliable, but AOS Thermal Compounds does not guarantee the results to be accurate and makes no warranties as to the fitness, merchantability, or suitability of any AOS material or product for any specific or general use and shall not be held liable for incidental or consequential damages of any kind. (040206)